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843.41042X00 10-03-02

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): HAYANO, et al.

Serial No.: 10/025,457

Filed: December 26, 2001

For: METHOD OF MANUFACTURING PHOTOMASK AND  
METHOD OF MANUFACTURING SEMICONDUCTOR  
INTEGRATED CIRCUIT DEVICE

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TC 1700

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APR 26 2002  
TC 1700INFORMATION DISCLOSURE STATEMENT  
UNDER 37 CFR 1.97 & 1.98Assistant Commissioner for Patents  
Washington, D.C. 20231

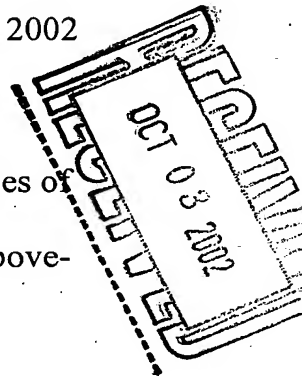
March 26, 2002

Sir:

Pursuant to Applicants' duty of disclosure, enclosed please find copies of documents to be considered by the Examiner during examination of the above-identified application. Also enclosed is an English abstract of one of the enclosed documents, that is, Japanese Patent Document No. 2000-17196. Further enclosed is a Form, substantially equivalent to Form PTO-1449, listing the enclosed documents.

This Information Disclosure Statement is being submitted within three months of the filing date of the above-identified application, and prior to a first Office Action on the merits in the above-identified application. Accordingly, requirements of 37 CFR 1.97(b) are satisfied.

To the extent that the enclosed documents are not in English, it is



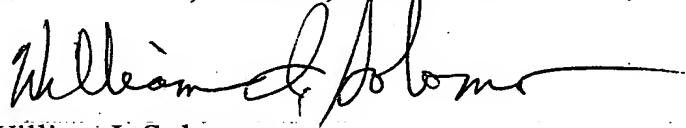
respectfully submitted that requirements of 37 CFR 1.98(a)(3) are satisfied at least by discussion of these references in the specification of the above-identified application, in the paragraph bridging pages 2 and 3 thereof, and by the English abstract of Japanese Patent Document No. 2000-17196.

In view of all of the foregoing, it is respectfully submitted that all applicable requirements of 37 CFR 1.97 and 1.98 have been satisfied, in connection with present submission of the enclosed documents. Accordingly, consideration of the enclosed documents, upon examination of the above-identified application, is respectfully requested.

To the extent necessary, Applicants petition for an extension of time under 37 CFR 1.136. Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to the Deposit Account No. 01-2135 (Case No. 843.41042X00) and please credit any excess fees to such Deposit Account.

Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP

A handwritten signature in cursive script, appearing to read "William I. Solomon", written over a horizontal line.

William I. Solomon  
Registration No. 28,565

Tel.: 703-312-6600  
WIS/slk  
Enclosures

Form PTO-1449	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DKT. NO. 843.41042X00	SERIAL NO. 10/025,457
<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b> (Use several sheets if necessary)		APPLICANT HAYANO, et al.	
		FILING DATE December 26, 2001	GROUP

## U.S. PATENT DOCUMENTS

Examiner Initial	Document Number	Date	Name	Class	Subclass	Filing Date
	AA					
	AB					
	AC					
	AD					
	AE					
	AF					
	AG					
	AH					
	AI					
	AJ					
	AK					
	AL					

## FOREIGN PATENT DOCUMENTS

Examiner Initial	Document Number	Date	Country	Class	Subclass	Translation /Abstract	
						Yes	No
	AM	2000-17196	1-18-00	Japan		X	
	AN						
	AO						
	AP						
	AQ						
	AR						
	AS						
	AT						

## OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

	AU	Nikkei Microdevices, April 2000, p. 145, 146.
	AV	Nikkei Microdevices, May 2000, p. 143-152.
	AW	Optical Microlithography XIII 1-3, March 2000, p. 647-657.
	AX	
	AY	
	AZ	
Examiner		Date Considered